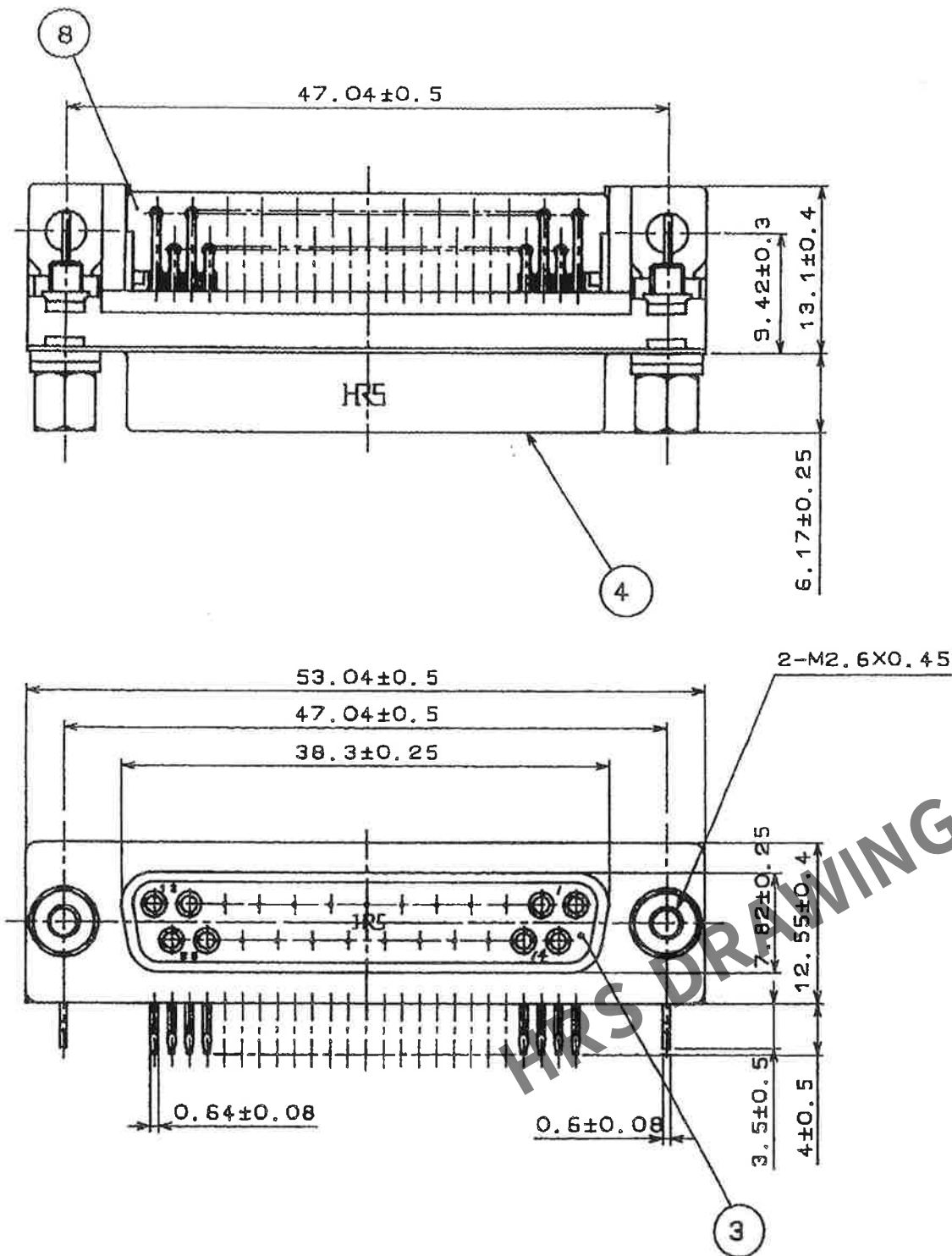
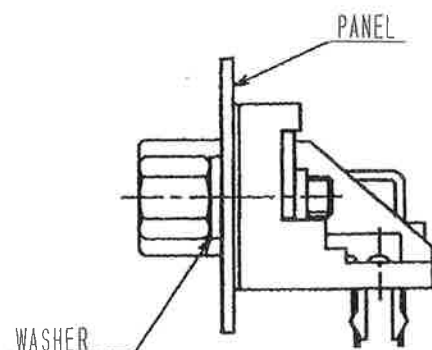


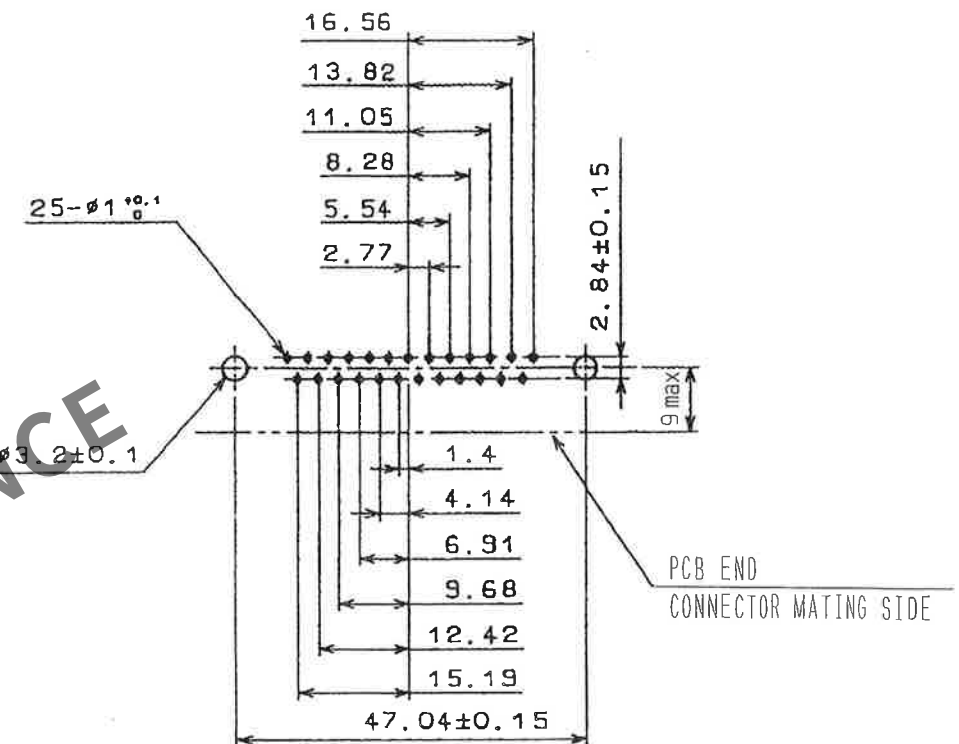


PATTERN OF MOUNTING CONNECTOR ON PCB



REMOVE ONE WASHER FOR 0.8 TO 1.2 OF PANEL THICKNESS.
REMOVE TWO WASHERS FOR 1.6 OF PANEL THICKNESS.

RECOMMENDED PC BOARD HOLE PATTERN
(SCALE 1:1)



NOTE. 1. PLEASE KEEP THE TOLERANCE TO LESS THAN ± 0.1
FOR THE DIMENSIONS WITHOUT TOLERANCE.
2. THICKNESS OF PC BOARD SHALL BE 1.6mm.

4	STEEL	NICKEL PLATING 1μm min UNDER PLATING : COPPER PLATING 5μm min	8	FERRITE	
3	PBT	BLACK, UL94V-0	7	STEEL	NICKEL PLATING 2μm min UNDER PLATING : COPPER PLATING 1μm min
2	PHOSPHOR BRONZE	CONTACT AREA : GOLD PLATING 0.2μm min LEAD AREA : GOLD PLATING 0.03μm min UNDER PLATING : NICKEL PLATING 2μm min	6	STEEL	NICKEL PLATING 2μm min UNDER PLATING : COPPER PLATING 3μm min
1	PHOSPHOR BRONZE	CONTACT AREA : GOLD PLATING 0.2μm min LEAD AREA : GOLD PLATING 0.03μm min UNDER PLATING : NICKEL PLATING 2μm min	5	PHOSPHOR BRONZE	TIN PLATING 3μm min UNDER PLATING : NICKEL PLATING 2μm min
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED CHECKED DATE
	HIROSE ELECTRIC CO., LTD.	APPROVED : <i>RI, TAKAYASU</i> 18.06.12	DRAWING NO.	EDC-028354-50-00	
		CHECKED : <i>RI, TAKAYASU</i> 18.06.12	PART NO.	RDBF-25SE-LNA(50)	
		DESIGNED : TS. ITO 18.06.12	CODE NO.	CL211-0881-9-50	
		DRAWN : TS. ITO 18.06.12			